# EE309 Advanced Programming Techniques for EE 

## Lecture 24: Modern systems INSU YUN (윤인수)

School of Electrical Engineering, KAIST
[Slides from 15-213: Introduction to Computer Systems at CMU]

## Systems

- A system is any collection of components combined to create an entity that is intended to accomplish some particular task(s) or goal(s).
- Three properties
- Correctness: To accomplish the goal
- Performance: To accomplish the goal with many users
- Security: To accomplish the goal with even malicious users


## What we have studied

■ Files IO

- Allocation
- Buffer overflow

■ Network programming
■ Concurrent programming
■ Cryptography

## Moore's Law Origins



April 19, 1965


## Cramming more components onto integrated circuits

With unit cost falling as the number of components per circuit rises, by 1975 economics may dictate squeezing as many as $\mathbf{6 5 , 0 0 0}$ components on a single silicon chip

By Gordon E. Moore

Director, Research and Development Laboratories, Fairchild Semiconductor division of Fairchild Camera and Instrument Corp.

## Moore's Law Origins



■ Moore's Thesis

- Minimize price per device
- Optimum number of devices / chip increasing $2 x$ / year
- Later
- 2x/2 years
- "Moore's Prediction"


## Moore's Law: 50 Years

Transistor Count by Year


- Desktop

■ Embedded
$\triangle$ GPU
$\times$ Server
—General Trend
-Moore's Prediction

Sample of
117 processorxchips

## What Moore's Law Has Meant



- 1976 Cray 1
- 250 M Ops/second
- ~170,000 chips
- 0.5B transistors
- 5,000 kg, 115 KW
- \$9M
- 80 manufactured

■ 2014 iPhone 6

- > 4 B Ops/second
- ~10 chips
- > 3B transistors
- $120 \mathrm{~g},<5 \mathrm{~W}$
- \$649
- 10 million sold in first 3 days


## What Moore's Law Has Meant

■ 1965 Consumer Product


■ 2015 Consumer Product


Apple A8 Processor
2 B transistors

## What Moore's Law Could Mean

- 2015 Consumer ■ 2065 Consumer Product Product

- Portable
- Low power
- Will drive markets \& innovation


## Requirements for Future Technology

- Must be suitable for portable, low-power operation
- Consumer products
- Internet of Things components
- Not cryogenic, not quantum
- Must be inexpensive to manufacture
- Comparable to current semiconductor technology
- $\mathrm{O}(1)$ cost to make chip with $\mathrm{O}(N)$ devices
- Need not be based on transistors
- Memristors, carbon nanotubes, DNA transcription, ...
- Possibly new models of computation
- But, still want lots of devices in an integrated system


## Moore's Law: 100 Years

Device Count by Year


## Visualizing $10^{17}$ Devices

If devices were the size of a grain of sand

$0.1 \mathrm{~m}^{3}$
$3.5 \times 10^{9}$ grains


1 million $\mathrm{m}^{3}$
$0.35 \times 10^{17}$ grains

## Increasing Transistor Counts

1. Chips have gotten bigger

- 1 area doubling / 10 years

2. Transistors have gotten smaller

- 4 density doublings / 10 years

Will these trends continue?

## Reaching 2065 Goal

- Target
- $10^{17}$ devices
- $400 \mathrm{~mm}^{2}$
- $L=63 \mathrm{pm}$


■ Is this possible?

Not with 2-d fabrication

## Fabricating in 3 Dimensions



Parameters


- $10^{17}$ devices
- 100,000 logical layers
- Each 50 nm thick
- ~1,000,000 physical layers
- To provide wiring and isolation
- $L=20 \mathrm{~nm}$
- $10 x$ smaller than today


2065 mm $^{3}$

## Towards scalability



## Distributed system

Distributed System


The Rise and Rise of A.I.
size $=$ no. of parameters

Amazon-owned Chinese Google Meta/Facebook Microsoft OpenAl Other


## Cloud computing



## Cyber Physical Systems



## Embedded systems in cars

## Rain-Sensing System



[^0]
## Cyber Physical Systems




## Operating system



## Next courses?

■ EE323: Computer network
■ EE324: Network programming

■ EE412: Introduction to Big Data analytics
■ EE414: Embedded system

■ EE415: Operating system for Electrical engineering


[^0]:    Electronic Stability Control (ESC)

